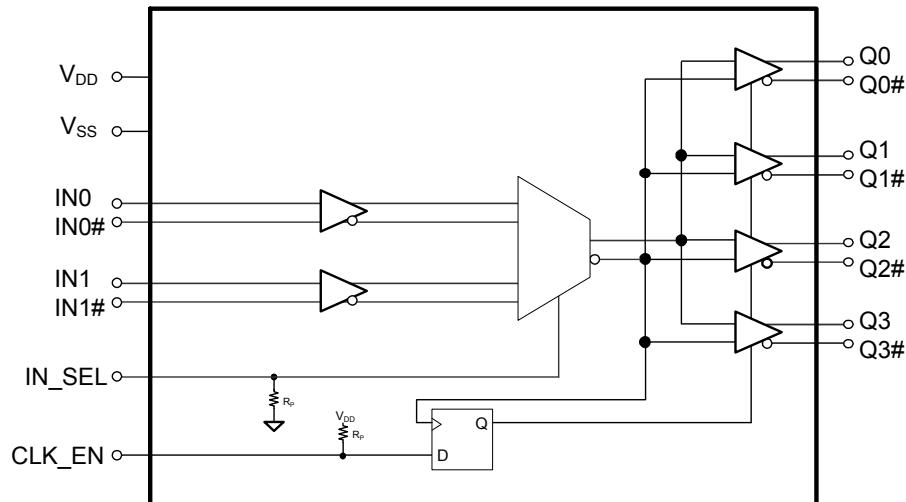


## 1:4 LVPECL Fanout Buffer with Selectable Clock Input

### Features

- Select one of two differential (LVPECL, LVDS, HCSL, or CML) input pairs to distribute to four LVPECL output pairs
- Translates any single-ended input signal to 3.3 V LVPECL levels with resistor bias on INx# input
- 30 ps maximum output-to-output skew
- 480 ps maximum propagation delay
- 0.15 ps maximum additive RMS phase jitter at 156.25 MHz (12 kHz to 20 MHz offset)
- Up to 1.5 GHz operation
- Synchronous clock enable function
- 20-pin TSSOP
- 2.5 V or 3.3 V operating voltage <sup>[1]</sup>
- Commercial and industrial operating temperature range

### Logic Block Diagram



#### Note

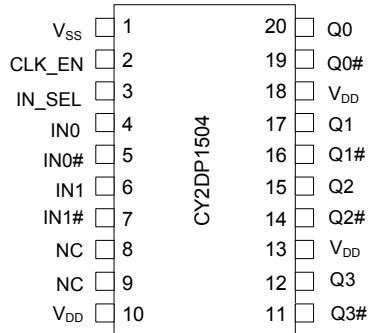
1. Input AC-coupling capacitors are required for voltage-translation applications.

## Contents

<b>Pinouts</b> .....	<b>3</b>
<b>Pin Definitions</b> .....	<b>3</b>
<b>Absolute Maximum Ratings</b> .....	<b>4</b>
<b>Operating Conditions</b> .....	<b>4</b>
<b>DC Electrical Specifications</b> .....	<b>5</b>
<b>Thermal Resistance</b> .....	<b>5</b>
<b>AC Electrical Specifications</b> .....	<b>6</b>
<b>Switching Waveforms</b> .....	<b>8</b>
<b>Application Information</b> .....	<b>10</b>
<b>Ordering Information</b> .....	<b>11</b>
Ordering Code Definitions .....	11
<b>Package Diagram</b> .....	<b>12</b>
<b>Acronyms</b> .....	<b>13</b>
<b>Document Conventions</b> .....	<b>13</b>
Units of Measure .....	13
<b>Document History Page</b> .....	<b>14</b>
<b>Sales, Solutions, and Legal Information</b> .....	<b>16</b>
Worldwide Sales and Design Support .....	16
Products .....	16
PSoC®Solutions .....	16
Cypress Developer Community .....	16
Technical Support .....	16

## Pinouts

**Figure 1. 20-pin TSSOP pinout**



## Pin Definitions

Pin No.	Pin Name	Pin Type	Description
1	V <sub>ss</sub>	Power	Ground
2	CLK_EN	Input	Synchronous clock enable. LVCMOS/LVTTL. When CLK_EN = Low, Q(0:3) outputs are held Low and Q(0:3)# outputs are held High
3	IN_SEL	Input	Input clock select pin. LVCMOS/LVTTL; When IN_SEL = Low, the IN0/IN0# differential input pair is active When IN_SEL = High, the IN1/IN1# differential input pair is active
4	IN0	Input	Differential (LVPECL, HCSL, LVDS, or CML) input clock. Active when IN_SEL = Low
5	IN0#	Input	Differential (LVPECL, HCSL, LVDS, or CML) complementary input clock. Active when IN_SEL = Low
6	IN1	Input	Differential (LVPECL, HCSL, LVDS, or CML) input clock. Active when IN_SEL = High
7	IN1#	Input	Differential (LVPECL, HCSL, LVDS, or CML) complementary input clock. Active when IN_SEL = High
8, 9	NC		No connection
10, 13, 18	V <sub>DD</sub>	Power	Power supply
11, 14, 16, 19	Q(0:3)#+	Output	LVPECL complementary output clocks
12, 15, 17, 20	Q(0:3)	Output	LVPECL output clocks

## Absolute Maximum Ratings

Parameter	Description	Condition	Min	Max	Unit
$V_{DD}$	Supply voltage	Non functional	-0.5	4.6	V
$V_{IN}^{[2]}$	Input voltage, relative to $V_{SS}$	Non functional	-0.5	Lesser of 4.0 or $V_{DD} + 0.4$	V
$V_{OUT}^{[2]}$	DC output or I/O voltage, relative to $V_{SS}$	Non functional	-0.5	Lesser of 4.0 or $V_{DD} + 0.4$	V
$T_S$	Storage temperature	Non functional	-55	150	°C
$ESD_{HBM}$	Electrostatic discharge (ESD) protection (Human body model)	JEDEC STD 22-A114-B	2000	-	V
$L_U$	Latch up		Meets or exceeds JEDEC Spec JESD78B IC Latch up Test		
UL-94	Flammability rating	At 1/8 in	V-0		
MSL	Moisture sensitivity level		3		

## Operating Conditions

Parameter	Description	Condition	Min	Max	Unit
$V_{DD}$	Supply voltage	2.5-V supply	2.375	2.625	V
		3.3-V supply	3.135	3.465	V
$T_A$	Ambient operating temperature	Commercial	0	70	°C
		Industrial	-40	85	°C
$t_{PU}$	Power ramp time	Power-up time for $V_{DD}$ to reach minimum specified voltage (power ramp must be monotonic).	0.05	500	ms

### Note

2. The voltage on any I/O pin cannot exceed the power pin during power up. Power supply sequencing is not required.

## DC Electrical Specifications

( $V_{DD} = 3.3\text{ V} \pm 5\%$  or  $2.5\text{ V} \pm 5\%$ ;  $T_A = 0\text{ }^\circ\text{C}$  to  $70\text{ }^\circ\text{C}$  (Commercial) or  $-40\text{ }^\circ\text{C}$  to  $85\text{ }^\circ\text{C}$  (Industrial))

Parameter	Description	Condition	Min	Max	Unit
$I_{DD}$	Operating supply current	All LVPECL outputs floating (internal $I_{DD}$ )	–	61	mA
$V_{IH1}$	Input high voltage, differential input clocks IN0 and IN0#, IN1 and IN1#		–	$V_{DD} + 0.3$	V
$V_{IL1}$	Input low voltage, differential input clocks IN0 and IN0#, IN1 and IN1#		–0.3	–	V
$V_{IH2}$	Input high voltage, CLK_EN, IN_SEL	$V_{DD} = 3.3\text{ V}$	2.0	$V_{DD} + 0.3$	V
$V_{IL2}$	Input low voltage, CLK_EN, IN_SEL	$V_{DD} = 3.3\text{ V}$	–0.3	0.8	V
$V_{IH3}$	Input high voltage, CLK_EN, IN_SEL	$V_{DD} = 2.5\text{ V}$	1.7	$V_{DD} + 0.3$	V
$V_{IL3}$	Input low voltage, CLK_EN, IN_SEL	$V_{DD} = 2.5\text{ V}$	–0.3	0.7	V
$V_{ID\_LDVS}^{[3]}$	LVDS input differential amplitude	See <a href="#">Figure 2 on page 8</a>	0.4	0.8	V
$V_{ID\_LVPECL}^{[3]}$	LVPECL/CML/HSCL input differential amplitude	See <a href="#">Figure 2 on page 8</a>	0.4	1.0	V
$V_{ICM}$	Input common mode voltage	See <a href="#">Figure 2 on page 8</a>	0.2	$V_{DD} - 0.2$	V
$I_{IH}$	Input high current, all inputs	Input = $V_{DD}^{[4]}$	–	150	$\mu\text{A}$
$I_{IL}$	Input low current, all inputs	Input = $V_{SS}^{[4]}$	–150	–	$\mu\text{A}$
$V_{OH}$	LVPECL output high voltage	Terminated with $50\ \Omega$ to $V_{DD} - 2.0$ <sup>[5]</sup>	$V_{DD} - 1.20$	$V_{DD} - 0.70$	V
$V_{OL}$	LVPECL output low voltage	Terminated with $50\ \Omega$ to $V_{DD} - 2.0$ <sup>[5]</sup>	$V_{DD} - 2.0$	$V_{DD} - 1.63$	V
$R_P$	Internal pull-up/pull-down resistance, LVCMS logic inputs	CLK_EN has pull-up only IN_SEL has pull-down only	60	165	$\text{k}\Omega$
$C_{IN}$	Input capacitance	Measured at 10 MHz; per pin	–	3	pF

## Thermal Resistance

Parameter <sup>[6]</sup>	Description	Test Conditions	20-pin TSSOP	Unit
$\theta_{JA}$	Thermal resistance (junction to ambient)	Test conditions follow standard test methods and procedures for measuring thermal impedance, in accordance with EIA/JESD51.	80	$^\circ\text{C/W}$
$\theta_{JC}$	Thermal resistance (junction to case)		16	$^\circ\text{C/W}$

### Notes

3.  $V_{ID}$  minimum of 400 mV is required to meet all output AC Electrical Specifications. The device is functional with  $V_{ID}$  minimum of greater than 200 mV.
4. Positive current flows into the input pin, negative current flows out of the input pin.
5. Refer to [Figure 3 on page 8](#).
6. These parameters are guaranteed by design and are not tested.

## AC Electrical Specifications

( $V_{DD} = 3.3 \text{ V} \pm 5\%$  or  $2.5 \text{ V} \pm 5\%$ ;  $T_A = 0 \text{ }^\circ\text{C}$  to  $70 \text{ }^\circ\text{C}$  (Commercial) or  $-40 \text{ }^\circ\text{C}$  to  $85 \text{ }^\circ\text{C}$  (Industrial))

Parameter	Description	Condition	Min	Typ	Max	Unit
$F_{IN}$	Input frequency	Differential Input	DC	—	1.5	GHz
		Single-ended CMOS Input <sup>[7]</sup>	DC	—	250	MHz
$F_{OUT}$	Output frequency	$F_{OUT} = F_{IN}$ , Differential Input	DC	—	1.5	GHz
		$F_{OUT} = F_{IN}$ , Single-ended CMOS Input <sup>[7]</sup>	DC	—	250	MHz
$V_{PP}$	LVPECL differential output voltage peak to peak, single-ended. Terminated with $50 \Omega$ to $V_{DD} - 2.0$ <sup>[8]</sup>	$F_{out} = DC$ to 150 MHz	600	—	—	mV
		$F_{out} = >150$ MHz to 1.5 GHz	400	—	—	mV
$t_{PD}^{[9]}$	Propagation delay differential input pair to differential output pair	Input rise/fall time < 1.5 ns (20% to 80%)	—	—	480	ps
$t_{ODC}^{[10]}$	Output duty cycle	50% duty cycle at input, Frequency range up to 1 GHz, Differential input	48	—	52	%
		50% duty cycle at input, Frequency range up to 250 MHz, Single-ended CMOS input <sup>[7]</sup>	45	—	55	%
$t_{SK1}^{[11]}$	Output-to-output skew	Any output to any output, with same load conditions at DUT	—	—	30	ps
$t_{SK1\ D}^{[11]}$	Device-to-device output skew	Any output to any output between two or more devices. Devices must have the same input and have the same output load.	—	—	150	ps
$PN_{ADD}$	Additive RMS phase noise, 156.25-MHz input, Rise/fall time < 150 ps (20% to 80%), $V_{ID} > 400$ mV or Input Swing = 3.0 V <sup>[7]</sup>	Offset = 1 kHz	—	—	-120	dBc/Hz
		Offset = 10 kHz	—	—	-130	dBc/Hz
		Offset = 100 kHz	—	—	-135	dBc/Hz
		Offset = 1 MHz	—	—	-145	dBc/Hz
		Offset = 10 MHz	—	—	-153	dBc/Hz
		Offset = 20 MHz	—	—	-155	dBc/Hz

### Notes

7. Refer to Application Information on page 10.
8. Refer to Figure 3 on page 8.
9. Refer to Figure 4 on page 8.
10. Refer to Figure 5 on page 8.
11. Refer to Figure 6 on page 9.

## AC Electrical Specifications (continued)

( $V_{DD} = 3.3\text{ V} \pm 5\%$  or  $2.5\text{ V} \pm 5\%$ ;  $T_A = 0\text{ }^\circ\text{C}$  to  $70\text{ }^\circ\text{C}$  (Commercial) or  $-40\text{ }^\circ\text{C}$  to  $85\text{ }^\circ\text{C}$  (Industrial))

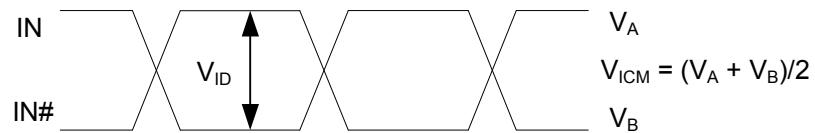
Parameter	Description	Condition	Min	Typ	Max	Unit
$t_{JIT}^{[12]}$	Additive RMS phase jitter (random)	156.25 MHz, 12 kHz to 20 MHz offset; input rise/fall time < 150 ps (20% to 80%), $V_{ID} > 400\text{ mV}$	—	—	0.15	ps
		156.25 MHz Sinewave, 12 kHz to 20 MHz offset, input rise/fall time < 150 ps (20% to 80%), Input Swing = 3.0 V <sup>[13]</sup>	—	—	0.15	ps
$t_R, t_F^{[14]}$	Output rise/fall time	50% duty cycle at input, 20% to 80% of full swing ( $V_{OL}$ to $V_{OH}$ ) Input rise/fall time < 1.5 ns (20% to 80%)	—	—	300	ps
$t_{SOD}$	Time from clock edge to outputs disabled	Synchronous clock enable (CLK_EN) switched Low	—	—	700	ps
$t_{SOE}$	Time from clock edge to outputs enabled	Synchronous clock enable (CLK_EN) switched High	—	—	700	ps

### Notes

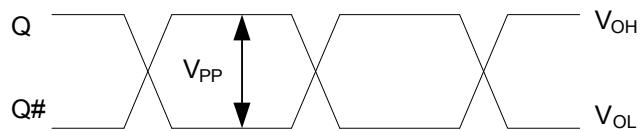
12. Refer to Figure 7 on page 9.
13. Refer to Application Information on page 10.
14. Refer to Figure 8 on page 9.

## Switching Waveforms

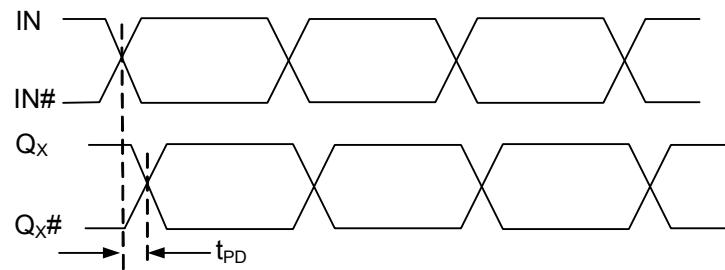
**Figure 2. Input Differential and Common Mode Voltages**



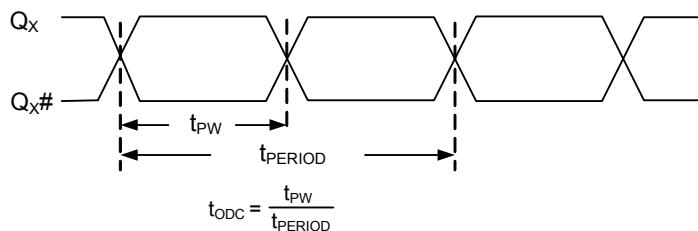
**Figure 3. Output Differential Voltage**



**Figure 4. Input to Any Output Pair Propagation Delay**

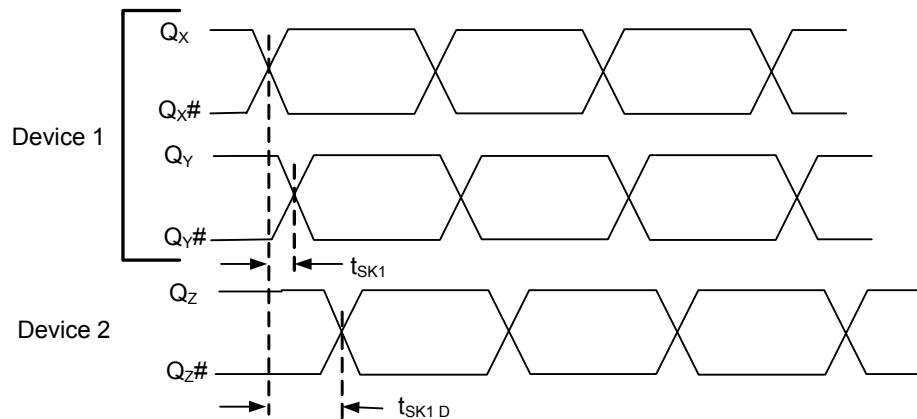


**Figure 5. Output Duty Cycle**

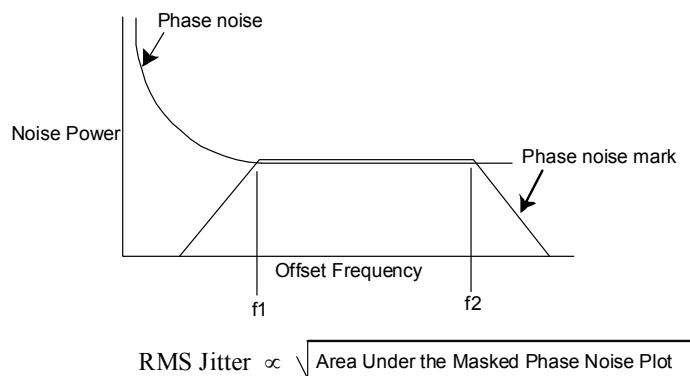


## Switching Waveforms (continued)

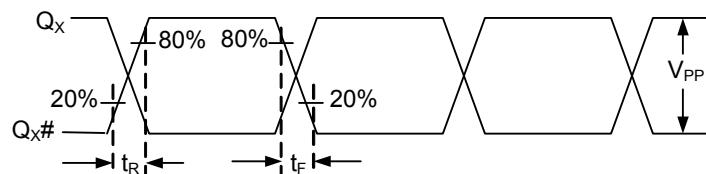
**Figure 6. Output-to-Output and Device-to-Device Skew**



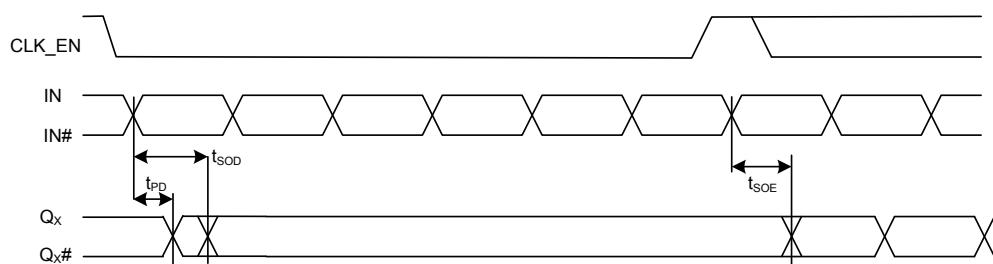
**Figure 7. RMS Phase Jitter**



**Figure 8. Output Rise/Fall Time**



**Figure 9. Synchronous Clock Enable Timing**



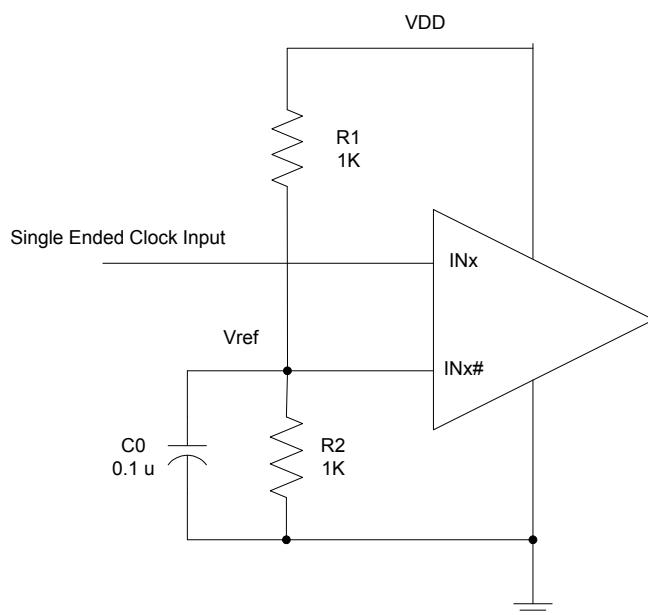
## Application Information

CY2DP1504 can be used with a single-ended CMOS input by biasing the Complementary Input Clock (INx#). “True” input pins (INx) of differential input pair can be fed with a single-ended CMOS input signal. The “complementary” input pin (INx#) of the same differential input pair can be biased with Vref.

Figure 10 shows the schematic which can be used to give single-ended CMOS input to the CY2DP1504.

The reference voltage  $V_{ref} = V_{DD}/2$  is generated by the bias resistors R1, R2 and capacitor C0. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the Vref in the center of the input voltage swing. For example, if the input clock swing is 2.5 V and  $V_{DD} = 3.3$  V, Vref should be 1.25 V and  $R2/R1 = 0.609$ .

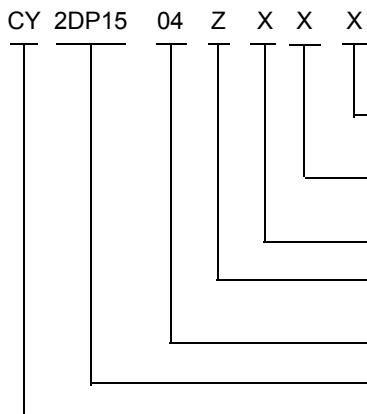
**Figure 10. Application Example**



## Ordering Information

Part Number	Type	Production Flow
<b>Pb-free</b>		
CY2DP1504ZXC	20-pin TSSOP	Commercial, 0 °C to 70 °C
CY2DP1504ZXCT	20-pin TSSOP – Tape and Reel	Commercial, 0 °C to 70 °C
CY2DP1504ZXI	20-pin TSSOP	Industrial, –40 °C to 85 °C
CY2DP1504ZXIT	20-pin TSSOP – Tape and Reel	Industrial, –40 °C to 85 °C

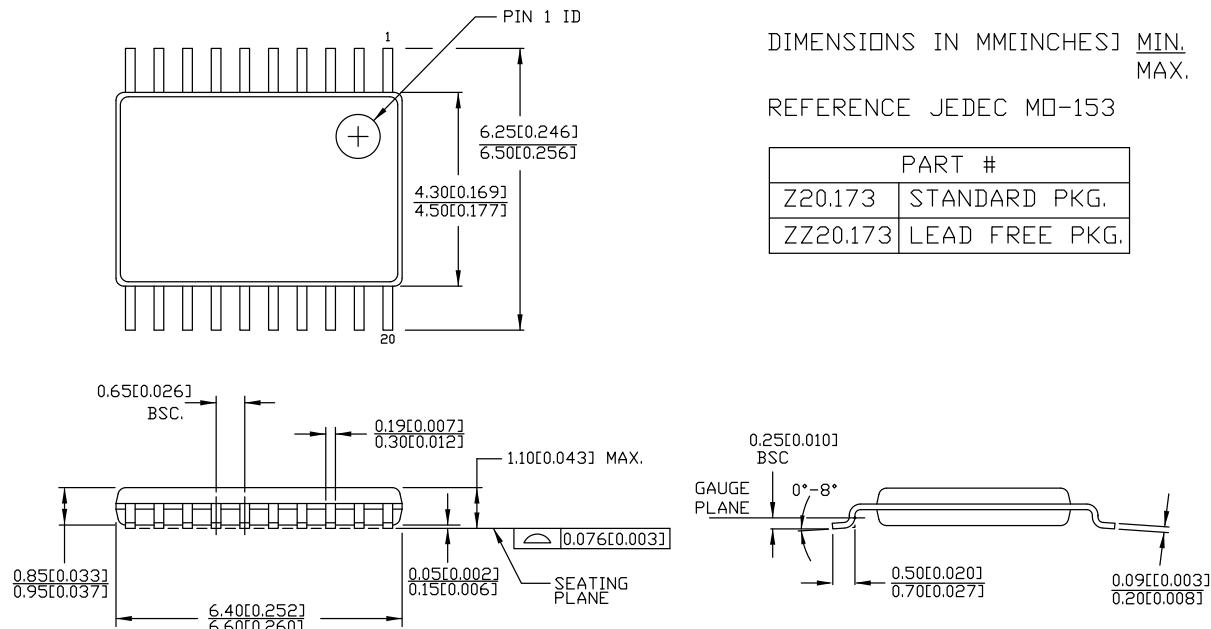
## Ordering Code Definitions



## Package Diagram

Figure 11. 20-pin TSSOP 4.40 mm Body Z20.173/ZZ20.173 Package Outline, 51-85118

### 20 Lead TSSOP 4.40 MM BODY



51-85118 \*E

## Acronyms

Acronym	Description
ESD	electrostatic discharge
HBM	human body model
HCSL	high-speed current steering logic
JEDEC	joint electron devices engineering council
LVCMOS	low-voltage complementary metal oxide semiconductor
LVPECL	low-voltage positive emitter-coupled logic
LVTTL	low-voltage transistor-transistor logic
RMS	root mean square
TSSOP	thin shrunk small outline package

## Document Conventions

### Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
dBc	decibels relative to the carrier
GHz	gigahertz
Hz	hertz
kΩ	kilohm
µA	microampere
µF	microfarad
µs	microsecond
mA	milliampere
ms	millisecond
mV	millivolt
MHz	megahertz
ns	nanosecond
Ω	ohm
pF	picofarad
ps	picosecond
V	volt
W	watt

## Document History Page

Document Title: CY2DP1504, 1:4 LVPECL Fanout Buffer with Selectable Clock Input Document Number: 001-56215				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	2782891	CXQ	10/09/09	New data sheet.
*A	2838916	CXQ	01/05/2010	<p>Changed status from "ADVANCE" to "PRELIMINARY".</p> <p>Changed from 0.34 ps to 0.25 ps maximum additive jitter in "Features" on page 1 and in <math>t_{JIT}</math> in the AC Electrical Specs table on page 5.</p> <p>Added <math>t_{PU}</math> spec to the Operating Conditions table on page 3.</p> <p>Changed max <math>I_{DD}</math> spec in the DC Electrical Specs table on page 4 from 60 mA to 61 mA.</p> <p>Change <math>V_{OH}</math> in the DC Electrical Specs table on page 4: minimum from <math>V_{DD}</math> - 1.15V to <math>V_{DD}</math> - 1.20V; maximum from <math>V_{DD}</math> - 0.75V to <math>V_{DD}</math> - 0.70V.</p> <p>Removed <math>V_{OD}</math> spec from the DC Electrical Specs table on page 4.</p> <p>Added <math>R_P</math> spec in the DC Electrical Specs table on page 4. Min = 60 k<math>\Omega</math>, Max = 140 k<math>\Omega</math>.</p> <p>Added a measurement definition for <math>C_{IN}</math> in the DC Electrical Specs table on page 4.</p> <p>Added <math>V_{PP}</math> spec to the AC Electrical Specs table on page 5. <math>V_{PP}</math> min = 600 mV for DC - 150 MHz and min = 400 mV for 150 MHz to 1.5 GHz.</p> <p>Changed letter case and some names of all the timing parameters in the AC Electrical Specs table on page 5 to be consistent with EROS.</p> <p>Lowered all additive phase noise mask specs by 3 dB in the AC Electrical Specs table on page 5.</p> <p>Added condition to <math>t_R</math> and <math>t_F</math> specs in the AC Electrical specs table on page 5 that input rise/fall time must be less than 1.5 ns (20% to 80%).</p> <p>Changed letter case and some names of all the timing parameters in Figures 3, 4, 5, 6 and 8, to be consistent with EROS.</p>
*B	3011766	CXQ	08/20/2010	<p>Changed maximum additive jitter from 0.25 ps to 0.11 ps in "Features" on page 1 and in <math>t_{JIT}</math> in the AC Electrical Specs table.</p> <p>Added note 3 to describe <math>I_{IH}</math> and <math>I_{IL}</math> specs.</p> <p>Removed reference to data distribution from "Functional Description".</p> <p>Changed <math>R_P</math> for differential inputs from 100 k<math>\Omega</math> to 150 k<math>\Omega</math> in the Logic Block Diagram and from 60 k<math>\Omega</math> min / 140 k<math>\Omega</math> max to 90 k<math>\Omega</math> min / 210 k<math>\Omega</math> max in the DC Electrical Specs table.</p> <p>Added max <math>V_{ID}</math> of 1.0V in DC Electrical Specs table.</p> <p>Updated phase noise specs for 1 k/10 k/100 k/1 M/10 M/20 MHz offset to -120/-130/-135/-150/-150/-150 dBc/Hz, respectively, in the AC Electrical Specs table.</p> <p>Added "Frequency range up to 1 GHz" condition to <math>t_{ODC}</math> spec.</p> <p>Added Ordering Code Definition.</p> <p>Updated package diagram.</p> <p>Added Acronyms.</p>
*C	3017258	CXQ	08/27/2010	Corrected Output Rise/Fall time diagram.
*D	3100234	CXQ	11/18/2010	<p>Updated Phase jitter to 0.15ps max from 0.11ps max.</p> <p>Changed <math>V_{IN}</math> and <math>V_{OUT}</math> specs from 4.0V to "lesser of 4.0 or <math>V_{DD}</math> + 0.4"</p> <p>Removed 200mA min LU spec, replaced with "Meets or exceeds JEDEC Spec JESD78B IC Latchup Test"</p> <p>Removed <math>R_P</math> spec for differential input clock pins <math>IN_X</math> and <math>IN_{X\#}</math>.</p> <p>Changed <math>C_{IN}</math> condition to "Measured at 10 MHz".</p> <p>Changed <math>PN_{ADD}</math> specs for 1MHz, 10MHz, and 20MHz offsets.</p> <p>Removed <math>t_S</math> and <math>t_H</math> specs from AC specs table.</p>
*E	3135201	CXQ	01/12/2011	<p>Removed "Preliminary" status heading.</p> <p>Removed resistors from <math>IN_X/IN_{X\#}</math> in <a href="#">Logic Block Diagram</a>.</p> <p>Added <a href="#">Figure 9</a> to describe <math>T_{SOE}</math> and <math>T_{SOD}</math>.</p>
*F	3090938	CXQ	02/25/2011	Post to external web.

**Document History Page** (continued)

<b>Document Title: CY2DP1504, 1:4 LVPECL Fanout Buffer with Selectable Clock Input</b> <b>Document Number: 001-56215</b>				
<b>Revision</b>	<b>ECN</b>	<b>Orig. of Change</b>	<b>Submission Date</b>	<b>Description of Change</b>
*G	3208968	CXQ	03/29/2011	Changed $R_P$ max from 140 k $\Omega$ to 165 k $\Omega$ and updated $R_P$ in <a href="#">Logic Block Diagram</a> .
*H	3308039	CXQ	07/11/2011	Updated supported differential input clock types to include LVPECL/LVDS/CML in Features, Functional Description, Pin Definitions, and DC specs table sections. Broke out $V_{ID}$ spec into $V_{ID\_LVDS}$ and $V_{ID\_LVPECL}$ specs.
*I	3395868	PURU	10/05/11	Updated supported differential input clock types to include HCSL in <a href="#">Features</a> , <a href="#">Pinouts</a> , and <a href="#">DC Electrical Specifications</a> table. Changed Min value of $V_{ICM}$ .
*J	3740406	CINM	09/11/2012	Minor text edits.
*K	3799048	PURU	12/05/2012	Updated <a href="#">Features</a> : Added "Translates any single-ended input signal to 3.3 V LVPECL levels with resistor bias on $INx\#$ input". Updated <a href="#">AC Electrical Specifications</a> : Added Note 7 and Note 13. Added $F_{IN}$ parameter values for "Single Ended CMOS Input" condition (Minimum value = DC, Maximum value = 250 MHz). Added $F_{OUT}$ parameter values for "Single Ended CMOS Input" condition (Minimum value = DC, Maximum value = 250 MHz). Updated $t_{PD}$ parameter (Changed description from "Propagation delay input pair to output pair" to "Propagation delay differential input pair to differential output pair"). Added $t_{ODC}$ parameter values for "Single Ended CMOS Input" condition (Minimum value = 45%, Maximum value = 55%). Updated description of $PN_{ADD}$ parameter (Replaced "Additive RMS phase noise, 156.25-MHz input, Rise/fall time < 150 ps (20% to 80%), $V_{ID} > 400$ mV" with "Additive RMS phase noise, 156.25-MHz input, Rise/fall time < 150 ps (20% to 80%), $V_{ID} > 400$ mV or Input Swing = 3.0 V <sup>[7]</sup> "). Added $t_{JIT}$ parameter values for the Condition "156.25 MHz Sinewave, 12 kHz to 20 MHz offset, input rise/fall time < 150 ps (20% to 80%), Input Swing = 3.0 V <sup>[13]</sup> " (Maximum value = 0.15 ps). Added <a href="#">Application Information</a> . Updated to new template.
*L	4586288	PURU	12/04/2014	Updated <a href="#">Functional Description</a> : Added "For a complete list of related documentation, <a href="#">click here</a> ." at the end. Updated <a href="#">Package Diagram</a> : spec 51-85118 – Changed revision from *D to *E.
*M	4959240	TAVA	10/12/2015	Updated to new template. Completing Sunset Review.
*N	5267558	PSR	05/13/2016	Added <a href="#">Thermal Resistance</a> . Updated to new template.
*O	5973884	AESATMP8	11/22/2017	Updated logo and Copyright.

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